



Docket No.: 067162-0021

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of	:	Customer Number: 20277
	:	
Ryu MAKABE, et al.	:	Confirmation Number: 4281
	:	
Application No.: 10/662,276	:	Group Art Unit: 2812
	:	
Filed: September 16, 2003	:	Examiner: Tuan H. Nguyen
	:	

For: SEMICONDUCTOR WAFER, SEMICONDUCTOR CHIP AND DICING METHOD OF A SEMICONDUCTOR WAFER

AMENDMENT

Mail Stop RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

A Request for Continued Examination and the following amendment and remarks are submitted in response to the Official Action dated November 15, 2005.

Amendments to the claims are reflected in the listing of claims which begins on page 2 of this paper. This listing of claims replaces all prior versions, and listings, of claims in the application.

Remarks begin on page 5 of this paper.